

## PATENT ASSIGNMENT

Electronic Version v1.1  
 Stylesheet Version v1.1

SUBMISSION TYPE:	NEW ASSIGNMENT								
NATURE OF CONVEYANCE:	ASSIGNMENT								
CONVEYING PARTY DATA									
<table border="1"> <thead> <tr> <th>Name</th> <th>Execution Date</th> </tr> </thead> <tbody> <tr> <td>Junichi SHIBATA</td> <td>01/17/2013</td> </tr> <tr> <td>Hideaki NITTA</td> <td>01/17/2013</td> </tr> <tr> <td>Shoichi MAEKAWA</td> <td>01/17/2013</td> </tr> </tbody> </table>		Name	Execution Date	Junichi SHIBATA	01/17/2013	Hideaki NITTA	01/17/2013	Shoichi MAEKAWA	01/17/2013
Name	Execution Date								
Junichi SHIBATA	01/17/2013								
Hideaki NITTA	01/17/2013								
Shoichi MAEKAWA	01/17/2013								
RECEIVING PARTY DATA									
Name:	TEIJIN CHEMICALS, LTD.								
Street Address:	2-1, Kasumigaseki 3-chome, Chiyoda-ku								
City:	Tokyo								
State/Country:	JAPAN								
Postal Code:	100-0013								
PROPERTY NUMBERS Total: 1									
<table border="1"> <thead> <tr> <th>Property Type</th> <th>Number</th> </tr> </thead> <tbody> <tr> <td>Application Number:</td> <td>13813674</td> </tr> </tbody> </table>		Property Type	Number	Application Number:	13813674				
Property Type	Number								
Application Number:	13813674								
CORRESPONDENCE DATA									
Fax Number:	2027218250								
<i>Correspondence will be sent via US Mail when the fax attempt is unsuccessful.</i>									
Email:	wlp@wenderoth.com								
Correspondent Name:	Wenderoth, Lind & Ponack, L.L.P.								
Address Line 1:	1030 15th Street, N.W.								
Address Line 2:	Suite 400 East								
Address Line 4:	Washington, DISTRICT OF COLUMBIA 20005								
ATTORNEY DOCKET NUMBER:	2013_0121A								
NAME OF SUBMITTER:	Andrea Pantleo								
Total Attachments: 2 source=ASSIGNMENT#page1.tif source=ASSIGNMENT#page2.tif									

OP \$40.00 13813674

PATENT

# ASSIGNMENT

In consideration of the sum of One Dollar (\$1.00) and other good and valuable consideration paid to each of the undersigned

Insert Name(s) of Inventor(s) Junichi SHIBATA, Hideaki NITTA and Shoichi MAEKAWA  
residing at Chiyoda-ku, TOKYO, JAPAN

Insert Name(s) of Assignee(s) TEIJIN CHEMICALS, LTD.  
Address of 2-1, Kasumigaseki 3-chome, Chiyoda-ku, TOKYO 100-0013 JAPAN

(hereinafter designated as the Assignee) the entire right, title and interest for the United States as defined in 35 USC 100, in the invention known as

Title of Invention MULTI-LAYER FILM, DECORATIVE MOLDING FILM AND MOLDED BODY

for which an application for patent in the United States has been executed by the undersigned

Date of Signing of Application on January 17, 2013

The undersigned agree(s) to execute all papers necessary in connection with this application and any continuing, divisional or reissue applications thereof and also to execute separate assignments in connection with such applications as the Assignee may deem necessary or expedient.

The undersigned agree(s) to execute all papers necessary in connection with any interference which may be declared concerning this application or continuation, division or reissue thereof and to cooperate with the Assignee in every way possible in obtaining evidence and going forward with such interference.

The undersigned agree(s) to execute all papers and documents and perform any act which may be necessary in connection with claims or provisions of the International Convention for Protection of Industrial Property or similar agreements.

The undersigned agree(s) to perform all affirmative acts which may be necessary to obtain a grant of a valid United States patent to the Assignee.

The undersigned hereby authorize(s) and request(s) the Commissioner of Patents to issue any and all Letters Patents of the United States resulting from said application or any division or divisions or continuing or reissue applications thereof to the said Assignee, as Assignee of the entire interest, and hereby covenants that he has (they have) full right to convey the entire interest herein assigned, and that he has (they have) not executed, and will not execute, any agreement in conflict herewith.

The undersigned hereby grant(s) the firm of WENDEROTH, LIND & PONACK, L.L.P., 2033 K Street, N.W., Suite 800, Washington, D.C. 20006-1021, the power to insert on this assignment any further identification which may be necessary or desirable in order to comply with the rules of the United States Patent Office for recordation of this document.

In witness whereof, executed by the undersigned on the date(s) opposite the undersigned name(s).

Date JAN. 17, 2013, Name of the Inventor Junichi Shikata  
 Date JAN. 17, 2013, Name of the Inventor Hideoaki Nitta  
 Date JAN. 17, 2013, Name of the Inventor Shoichi Maekawa  
 Date \_\_\_\_\_, Name of the Inventor \_\_\_\_\_  
 Date \_\_\_\_\_, Name of the Inventor \_\_\_\_\_  
 Date \_\_\_\_\_, Name of the Inventor \_\_\_\_\_  
 Date \_\_\_\_\_, Name of the Inventor \_\_\_\_\_

(This assignment should preferably be acknowledged before a United States Consul. If not, then the execution by the Inventor(s) should be witnessed by at least two witnesses who sign here.)

Witness *[Signature]*  
 Witness \_\_\_\_\_

### ACKNOWLEDGMENT

\_\_\_\_\_  
 \_\_\_\_\_ } ss

This \_\_\_\_\_ day of \_\_\_\_\_, 19\_\_\_\_, before me personally came the above-named me personally known as the individual(s) who executed the foregoing assignment, who did acknowledge to me that he (they) executed the same of his (their) own free will for the purposes therein set forth.

SEAL

\_\_\_\_\_  
 Official Signature  
 \_\_\_\_\_  
 Official Title

The above application may be more particularly identified as follows:  
 U.S. Application Serial No. \_\_\_\_\_ Filing Date \_\_\_\_\_  
 Applicant Reference Number \_\_\_\_\_ Atty Docket No. \_\_\_\_\_  
 Title of Invention \_\_\_\_\_  
 \_\_\_\_\_